



INTERNATIONAL
GEMOLOGICAL
INSTITUTE

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LABORATORY GROWN DIAMOND REPORT

July 13, 2026

IGI Report Number

Description

Shape and Cutting Style

Measurements

GRADING RESULTS

Carat Weight

Color Grade

Clarity Grade

ADDITIONAL GRADING INFORMATION

Polish

Symmetry

Fluorescence

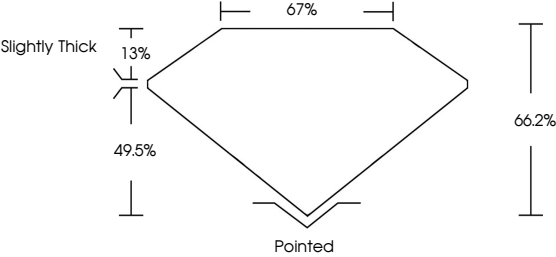
Inscription(s)

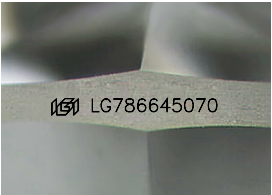
Comments: As Grown - No indication of post-growth treatment.
This Laboratory Grown Diamond was created by High Pressure High Temperature (HPHT) growth process.
Type II

LG786645070

Report verification at [igi.org](#)

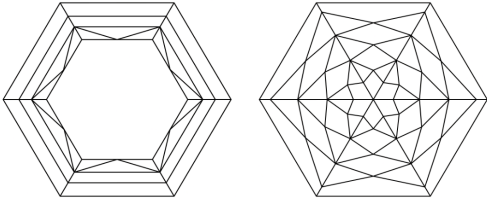
PROPORTIONS





Sample Image Used

CLARITY CHARACTERISTICS



KEY TO SYMBOLS

Red symbols indicate internal characteristics.
Green symbols indicate external characteristics.

COLOR

D	E	F	G	H	I	J	Faint	Very Light	Light
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CLARITY

FL	IF	VVS ¹⁻²	VS ¹⁻²	SI ¹⁻²	I ¹⁻³
Flawless	Internally Flawless	Very Very Slightly Included	Very Slightly Included	Slightly Included	Included

LABORATORY GROWN DIAMOND REPORT

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IGI Report No LG786645070

HEXAGONAL MIXED CUT

9.68 X 8.41 X 5.57 MM

3.09 CARATS

D

FLAWLESS

66.2%

67%

Slightly Thick

Pointed

EXCELLENT

EXCELLENT

NONE

IGI LG786645070

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